XP161A11A1PR

Power MOSFET



■GENERAL DESCRIPTION

The XP161A11A1PR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. A gate protect diode is built-in to prevent static damage.

The small SOT-89 package makes high density mounting possible.

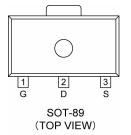
■ APPLICATIONS

- Notebook PCs
- •Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

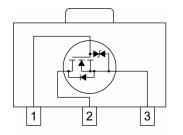
■FEATURES

Low On-State Resistance : Ro	ls(on)=0.065 Ω @ Vgs=10V
: Rc	is(on)=0.105 Ω @ Vgs=4.5V
Ultra High-Speed Switching	
Gate Protect Diode Built-in	
Driving Voltage : 4.8	5V
N-Channel Power MOSFET	
DMOS Structure	
Small Package : SO	OT-89

■ PIN CONFIGURATION



■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	D	Drain
3	S	Source

■ABSOLUTE MAXIMUM RATINGS

	Ta = 25					
PARAMETER	SYMBOL	RATINGS	UNITS			
Drain - Source Voltage	Vdss	30	V			
Gate - Source Voltage	Vgss	±20	V			
Drain Current (DC)	ld	4	А			
Drain Current (Pulse)	ldp	16	А			
Reverse Drain Current	ldr	4	А			
Channel Power Dissipation *	Pd	2	W			
Channel Temperature	Tch	150	°C			
Storage Temperature Range	Tstg	-55~150	°C			

* When implemented on a ceramic PCB

■ ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics Ta = 25°C					a = 25°C	
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=30V, Vgs= 0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs= $\pm 20V$, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	1.0	-	2.5	V
Drain-Source On-State Resistance*1	Rds(on)	ld= 2A, Vgs= 10V	-	0.05	0.065	Ω
		Id= 2A, Vgs= 4.5V	-	0.075	0.105	Ω
Forward Transfer Admittance *1	Yfs	ld= 2A, Vds= 10V	-	5.5	-	S
Body Drain Diode Forward Voltage	Vf	lf= 4A, Vgs= 0V	-	0.85	1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

					10	a – 20 0
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f= 1MHz	-	270	-	pF
Output Capacitance	Coss		-	150	-	pF
Feedback Capacitance	Crss		-	55	-	pF

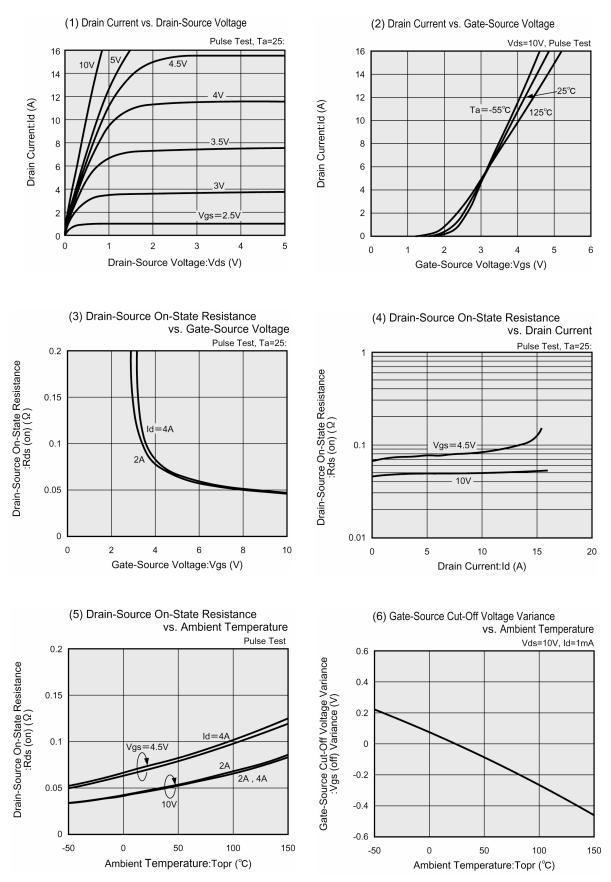
Switching Characteristics

Switching Characteristics					Т	ā = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id=2A Vdd= 10V	-	10	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	35	-	ns
Fall Time	tf		-	15	-	ns

Thermal Characteristics

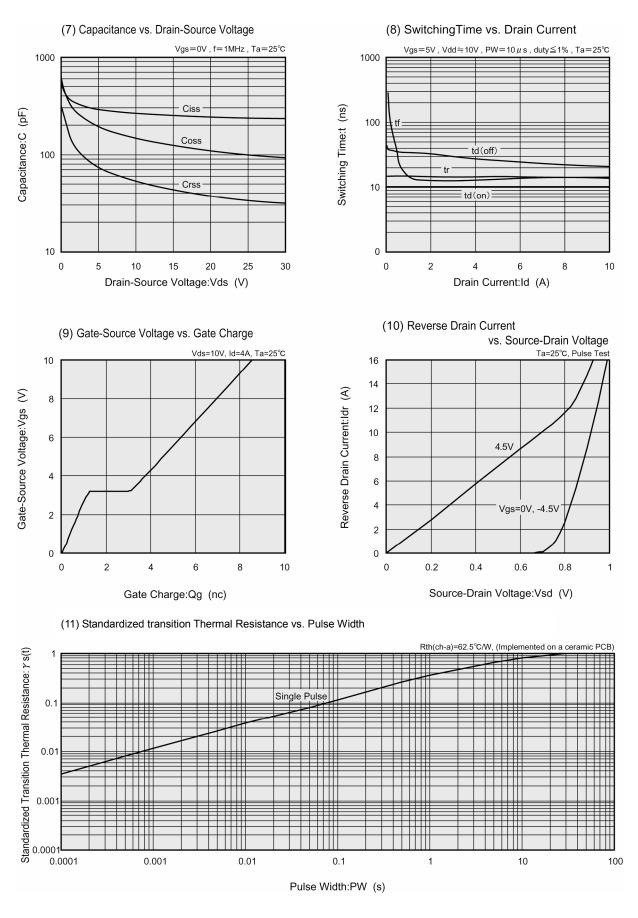
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	62.5	-	°C/W





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■TYPICAL PERFOMANCE CHARACTERISTICS (Continued)



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